Vishay Siliconix



## **Power MOSFET**

# TO-220AB G G N-Channel MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	500				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.85			
Q <sub>g</sub> max. (nC)	38				
Q <sub>gs</sub> (nC)	9.0				
Q <sub>gd</sub> (nC)	18				
Configuration	Single				

#### **FEATURES**

- Low gate charge Q<sub>g</sub> results in simple drive requirement
- Improved gate, avalanche, and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Effective Coss specified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

#### APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptable power supply
- · High speed power switching

#### TYPICAL SMPS TOPOLOGIES

- Two transistor forward
- Half bridge
- Full bridge

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF840APbF
Lead (Pb)-free and halogen-free	IRF840APbF-BE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	500	- v	
Gate-source voltage			V <sub>GS</sub>	± 30		
Continuous drain current	Vec at 10 V	T <sub>C</sub> = 25 °C	I <sub>D</sub>	8.0		
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		5.1	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	32	1	
Linear derating factor				1.0	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	510	mJ	
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	8.0	A	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Maximum power dissipation	T <sub>C</sub> =	25 °C	P <sub>D</sub> 125		W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	*0	
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s		-	300	- °C	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N·m	

#### Notes

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a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 16 mH,  $R_q = 25 \Omega$ ,  $I_{AS} = 8.0$  A (see fig. 12)

c.  $I_{SD} \le 8.0$  A, dl/dt  $\le 100$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C

d. 1.6 mm from case

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	_		62					
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50		-		°C/W			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-		1.0					
	1100								
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	unless otherw	ise noted)							
PARAMETER	SYMBOL	TEST	CONDITIC	DNS	MIN.	TYP.	MAX.	UNIT	
Static					I	•	1		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = 25	ο μΑ	500	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>I</sub>	$_{\rm D} = 1  \rm{mA}$	-	0.58	-	V/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2.0	-	4.0	V		
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA		
Zero gate voltage drain current		V <sub>DS</sub> = 5	00 V, V <sub>GS</sub>	= 0 V	-	-	25	<u> </u>	
	I <sub>DSS</sub>	V <sub>DS</sub> = 400 V, \	/ <sub>GS</sub> = 0 V, <sup>•</sup>	T <sub>J</sub> = 125 °C	-	-	250	μA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 4.8 A <sup>b</sup>	-	-	0.85	Ω	
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 5	0 V, I <sub>D</sub> = 4.	.8 A <sup>b</sup>	3.7	-	-	S	
Dynamic						•			
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5 $V_{GS} = 0 V; V_{DS} = 1.0 V, f = 1.0 \text{ MHz}$ $V_{GS} = 0 V; V_{DS} = 400 V, f = 1.0 \text{ MHz}$		-	1018	-	pF		
Output capacitance	C <sub>oss</sub>			-	155	-			
Reverse transfer capacitance	C <sub>rss</sub>			-	8.0	-			
Output capacitance	C <sub>oss</sub>				1490				
Output capacitance	C <sub>oss</sub>				42				
Effective output capacitance	C <sub>oss</sub> eff.	$V_{GS} = 0 V; V_{DS} = 0 V to 400 V^{c}$			56				
Total gate charge	Qg			I <sub>D</sub> = 8 A, V <sub>DS</sub> = 400 V, see fig. 6 and 13 <sup>b</sup>	-	-	38	nC	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V			-	-	9.0		
Gate-drain charge	Q <sub>gd</sub>		300 119	see lig. 0 and 15 *		-	18	1	
Turn-on delay time	t <sub>d(on)</sub>				-	11	-		
Rise time	t <sub>r</sub>	$V_{DD} = 2$	250 V, I <sub>D</sub> =	8 A	-	23	-		
Turn-off delay time	t <sub>d(off)</sub>	$R_g = 9.1 \ \Omega$ , $R_D = 31 \ \Omega$ , see fig. 10 <sup>b</sup> f = 1 MHz, open drain		-	26	-	ns		
Fall time	t <sub>f</sub>			-	19	-			
Gate input resistance	R <sub>g</sub>			0.7	-	3.7	Ω		
Drain-Source Body Diode Characteristi	cs								
Continuous source-drain diode current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8.0	A		
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	32			
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C,	I <sub>S</sub> = 8 A, V	<sub>GS</sub> = 0 V <sup>b</sup>	-	-	2.0	V	
Body diode reverse recovery time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 8 A, dl/dt = 100 A/μs <sup>b</sup>		-	422	633	ns		
Body diode reverse recovery charge	Q <sub>rr</sub>			_	2.16	3.24	μC		

Notes

Forward turn-on time

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

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Intrinsic turn-on time is negligible (turn-on is dominated by  $L_S$  and  $L_D$ )



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

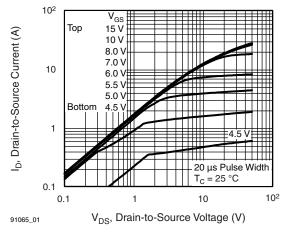


Fig. 1 - Typical Output Characteristics,  $T_C = 25 \ ^{\circ}C$ 

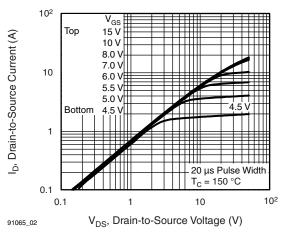


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150 °C

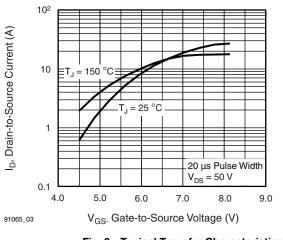


Fig. 3 - Typical Transfer Characteristics

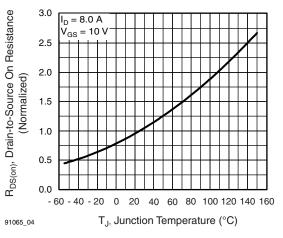


Fig. 4 - Normalized On-Resistance vs. Temperature

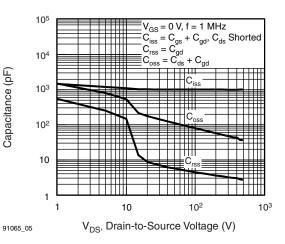


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

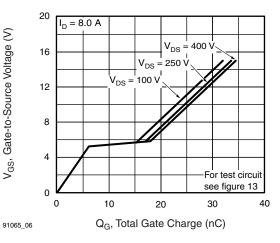


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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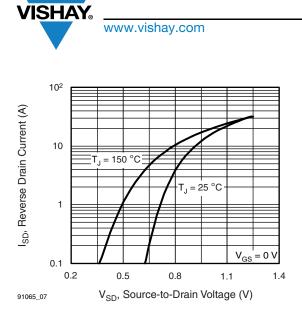


Fig. 7 - Typical Source-Drain Diode Forward Voltage

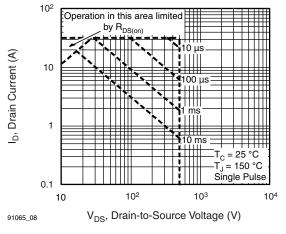


Fig. 8 - Maximum Safe Operating Area

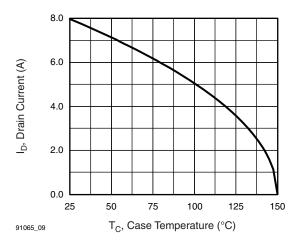


Fig. 9 - Maximum Drain Current vs. Case Temperature

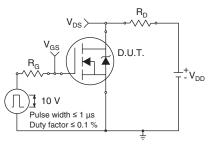


Fig. 10a - Switching Time Test Circuit

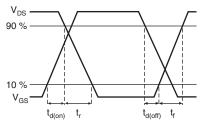
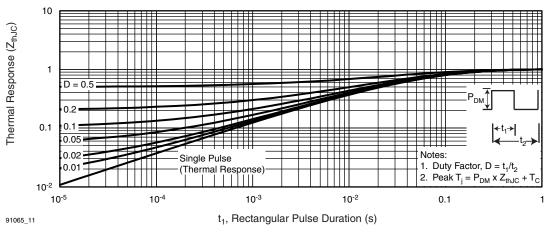
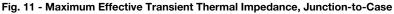


Fig. 10b - Switching Time Waveforms





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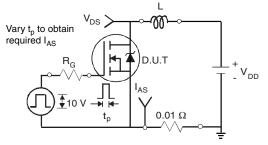


Fig. 12a - Unclamped Inductive Test Circuit

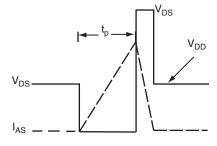


Fig. 12b - Unclamped Inductive Waveforms

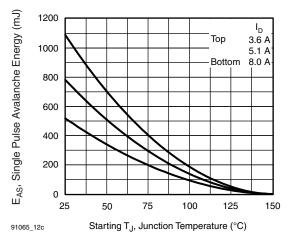


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

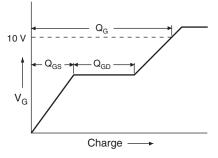


Fig. 12d - Basic Gate Charge Waveform

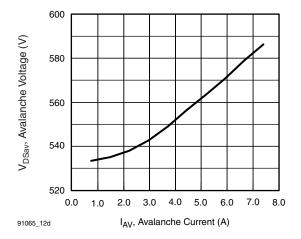


Fig. 13a - Typical Drain-to-Source Voltage vs. Avalanche Current

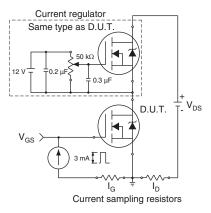


Fig. 13b - Gate Charge Test Circuit

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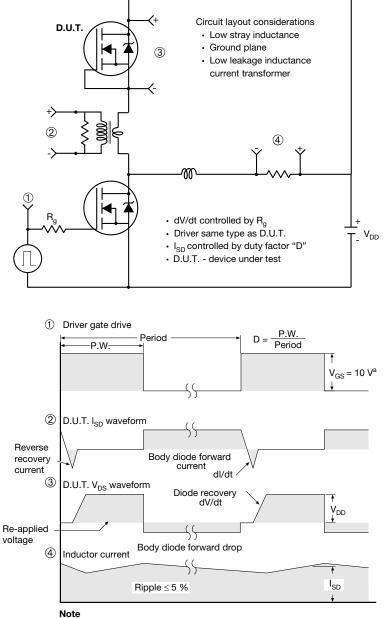
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

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